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Kind regards,

Team Nexperia

**Product data sheet** 





## 1. Product profile

#### 1.1 General description

High-speed switching diode fabricated in planar technology, and encapsulated in a small hermetically sealed glass SOD80C Surface-Mounted Device (SMD) package.

#### 1.2 Features and benefits

- High switching speed: max. 4 ns
- General application
- Reverse voltage: max. 50 V
- Repetitive peak reverse voltage: max. 75 V
- Repetitive peak forward current: max. 450 mA
- Small hermetically sealed glass SMD package

#### **1.3 Applications**

- High-speed switching
- Military and industrial applications

#### 1.4 Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F</sub>	forward current		<u>[1]</u> _	-	200	mA
V <sub>R</sub>	reverse voltage		-	-	50	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA	740	-	880	mV

[1] Device mounted on an FR4 Printed-Circuit Board (PCB).

## 2. Pinning information

Table 2.	Pinning	
Pin	Description	Simplified outline Graphic symbo
1	cathode	<u>[1]</u>
2	anode	

[1] The marking band indicates the cathode.



**High-speed diode** 

## 3. Ordering information

Table 3.         Ordering information							
Type number	Package						
	Name	Description	Version				
PMLL4153	-	hermetically sealed glass surface-mounted package; 2 connectors	SOD80C				

## 4. Marking

Table 4.   Marking codes	
Type number	Marking code
PMLL4153	marking band

## 5. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage		-	75	V
V <sub>R</sub>	reverse voltage		-	50	V
l <sub>F</sub>	forward current		<u>[1]</u> _	200	mA
I <sub>FRM</sub>	repetitive peak forward current		-	450	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave	[2]		
		$t_p = 1 \ \mu s$	-	4	А
		t <sub>p</sub> = 1 ms	-	1	А
		t <sub>p</sub> = 1 s	-	0.5	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> _	500	mW
Tj	junction temperature		-	200	°C
T <sub>stg</sub>	storage temperature		-65	+200	°C

[1] Device mounted on an FR4 PCB.

[2]  $T_j = 25 \circ C$  prior to surge.

## 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-t)</sub>	thermal resistance from junction to tie-point		-	-	300	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	350	K/W

[1] Device mounted on an FR4 PCB.

**High-speed diode** 

## 7. Characteristics

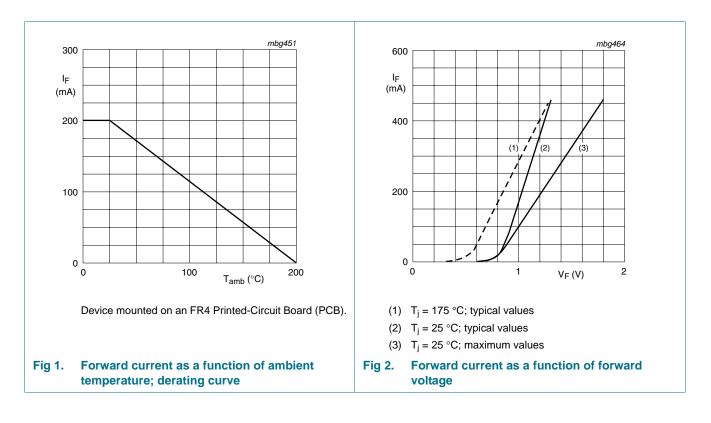
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub> forward	forward voltage	I <sub>F</sub> = 0.1 mA	490	-	550	mV
		I <sub>F</sub> = 0.25 mA	530	-	590	mV
		I <sub>F</sub> = 1 mA	590	-	670	mV
		$I_F = 2 \text{ mA}$	620	-	700	mV
		I <sub>F</sub> = 10 mA	700	-	810	mV
		I <sub>F</sub> = 50 mA	740	-	880	mV
I <sub>R</sub> rev	reverse current	V <sub>R</sub> = 50 V	-	-	0.05	μA
		$V_R$ = 50 V; $T_j$ = 150 °C	-	-	50	μA
C <sub>d</sub>	diode capacitance	$V_R = 0 V$ ; f = 1 MHz	-	-	2	pF
t <sub>rr</sub>	reverse recovery time		<u>[1]</u> -	-	4	ns
			[2] _	-	2	ns
t <sub>fr</sub>	forward recovery time		[3]	-	10	ns

## Table 7.CharacteristicsT = 25 % unlose otherwise and

[1] When switched from  $I_F$  = 10 mA to  $I_R$  = 10 mA;  $R_L$  = 100  $\Omega;$  measured at  $I_R$  = 1 mA.

[2] When switched from I\_F = 10 mA to I\_R = 60 mA; R\_L = 100  $\Omega$ ; measured at I\_R = 1 mA.

[3] When switched to  $I_F$  = 200 mA;  $t_r$  = 0.4 ns; measured at  $V_F$  = 1 V.

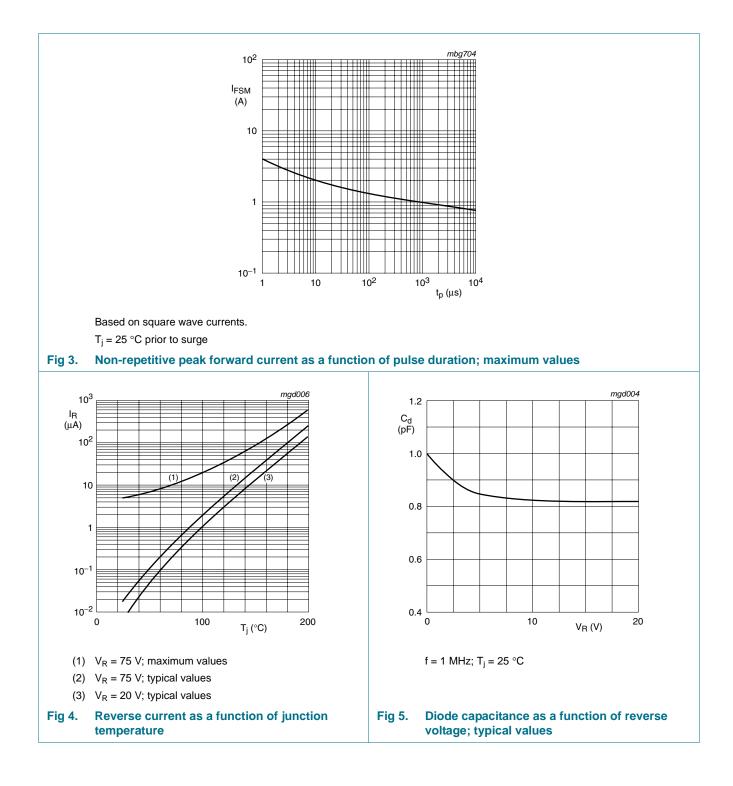


3 of 10

#### **NXP Semiconductors**

# **PMLL4153**

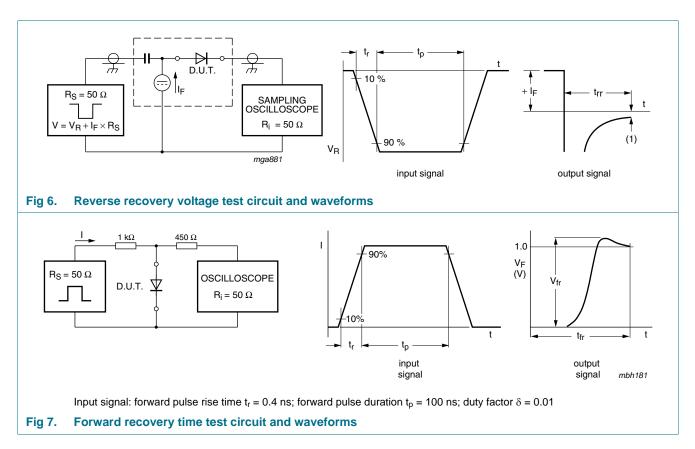
#### **High-speed diode**



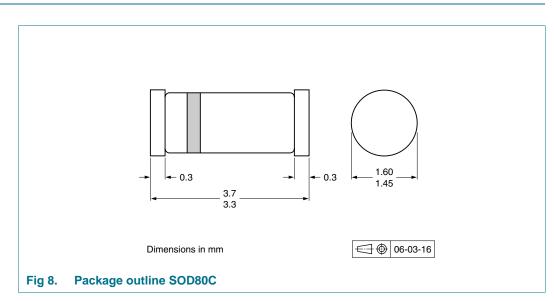
**PMLL4153** 

**High-speed diode** 

## 8. Test information



## 9. Package outline



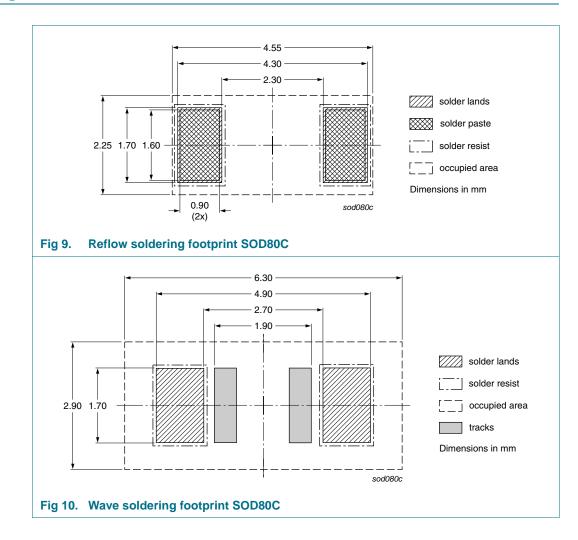
5 of 10

**High-speed diode** 

## **10. Packing information**

	cking meth	ods last three digits of the 12NC ordering code.[1]		
Type number	Package	Description	Packing	g quantity
			2500	10000
PMLL4153	SOD80C	4 mm pitch, 8 mm tape and reel	-115	-135
[1] For further in	nformation an	d the availability of packing methods, see Section 14.		

## 11. Soldering



PMLL4153 Product data sheet

## 12. Revision history

Table 9. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PMLL4153 v.3	20100819	Product data sheet	-	PMLL4150_2
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply w	vith the new identity
	<ul> <li>Type numb</li> </ul>	ers PMLL4150 and PMLL41	51 removed.	
	<ul> <li>Legal texts</li> </ul>	have been adapted to the n	ew company name whe	ere appropriate.
	Table 1 "Qu	ick reference data": added		
	Section 4 "I	Marking": added		
	Figure 1: up	odated		
	<ul> <li><u>Figure 8</u>: st</li> </ul>	perseded by minimized pac	ckage outline drawing	
	Section 10	Packing information": adde	d	
	Section 11	<u>'Soldering"</u> : added		
	Section 13	<u>'Legal information</u> ": updated	k	
PMLL4150_2	19960918	Product specification	-	PMLL4150_1
PMLL4150_1	19960423	Product specification	-	-

## 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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# **PMLL4153**

## **15. Contents**

1	Product profile 1
1.1	General description 1
1.2	Features and benefits1
1.3	Applications 1
1.4	Quick reference data 1
2	Pinning information 1
3	Ordering information 2
4	Marking 2
5	Limiting values 2
6	Thermal characteristics 2
7	Characteristics 3
8	Test information 5
9	Package outline 5
10	Packing information 6
11	Soldering 6
12	Revision history 7
13	Legal information 8
13.1	Data sheet status 8
13.2	Definitions8
13.3	Disclaimers 8
13.4	Trademarks 9
14	Contact information 9
15	Contents 10

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